

# NSR0320MW2T1G, NSVR0320MW2T1G, NSR0320MW2T3G

## Schottky Barrier Diodes

These Schottky barrier diodes are designed for high current, handling capability, and low forward voltage performance.

### Features

- Low Forward Voltage – 0.24 Volts (Typ) @  $I_F = 10 \text{ mAdc}$
- High Current Capability
- ESD Rating:
  - ◆ Human Body Model: CLASS 3B
  - ◆ Machine Model: C
- AEC Qualified and PPAP Capable
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant\*

### MAXIMUM RATINGS ( $T_J = 125^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Reverse Voltage	$V_R$	20	Vdc
Peak Reverse Voltage	$V_{RM}$	23	V
Forward Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_F$	200 2.0	mW mW/ $^\circ\text{C}$
Forward Current (DC) Continuous	$I_F$	1	A
Forward Current $t = 8.3 \text{ ms}$ Half Sinewave	$I_F$	5	A
Junction Temperature Range	$T_J$	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



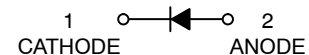
ON Semiconductor®

<http://onsemi.com>

## HIGH CURRENT SCHOTTKY BARRIER DIODE



SOD-323  
CASE 477  
STYLE 1



### MARKING DIAGRAM



RD = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

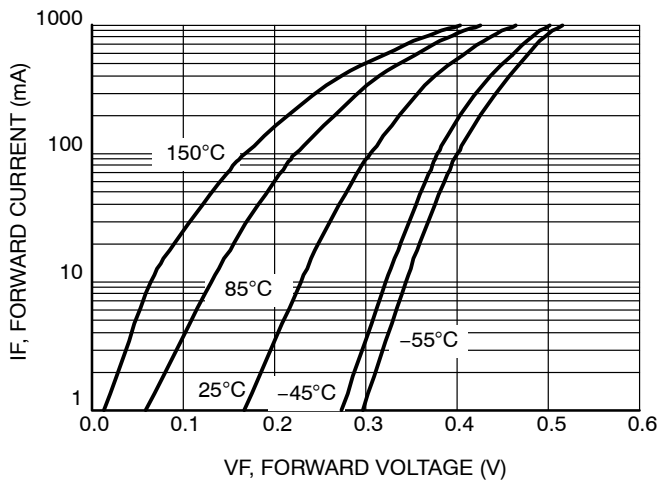
Device	Package	Shipping†
NSR0320MW2T1G	SOD-323 (Pb-Free)	3,000 / Tape & Reel
NSVR0320MW2T1G	SOD-323 (Pb-Free)	3,000 / Tape & Reel
NSR0320MW2T3G	SOD-323 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

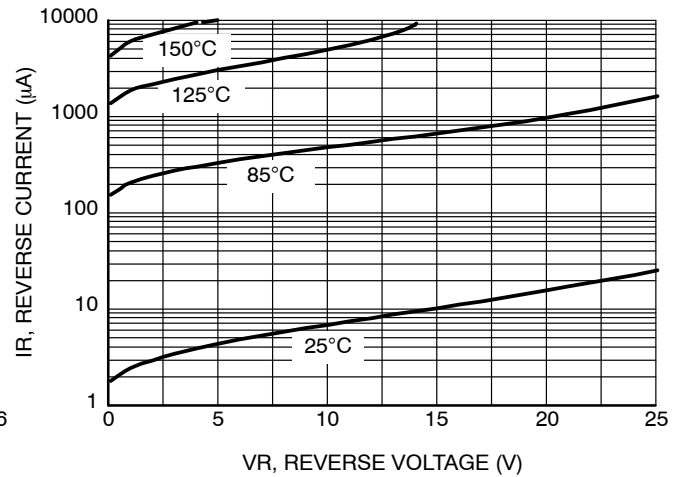
# NSR0320MW2T1G, NSVR0320MW2T1G, NSR0320MW2T3G

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

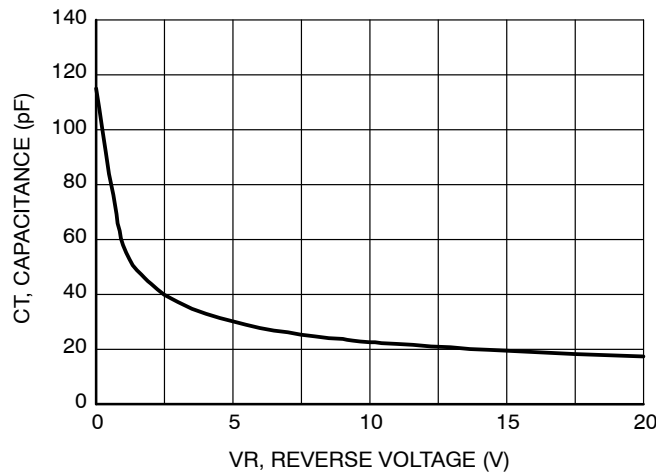
Characteristic	Symbol	Min	Typ	Max	Unit
Total Capacitance (V <sub>R</sub> = 5.0 V, f = 1.0 MHz)	C <sub>T</sub>	-	25	29	pF
Reverse Leakage (V <sub>R</sub> = 15 V)	I <sub>R</sub>	-	10	50	μA
Reverse Leakage (V <sub>R</sub> = 2.0 V @ 85°C)	I <sub>R</sub>	-	200	300	μA
Reverse Leakage (V <sub>R</sub> = 15.0 V @ 85°C)	I <sub>R</sub>	-	450	1000	μA
Forward Voltage (I <sub>F</sub> = 10 mA)	V <sub>F</sub>	-	0.24	0.27	V
Forward Voltage (I <sub>F</sub> = 100 mA)	V <sub>F</sub>	-	0.30	0.35	V
Forward Voltage (I <sub>F</sub> = 900 mA)	V <sub>F</sub>	-	0.45	0.50	V



**Figure 1. Forward Voltage**



**Figure 2. Leakage Current**

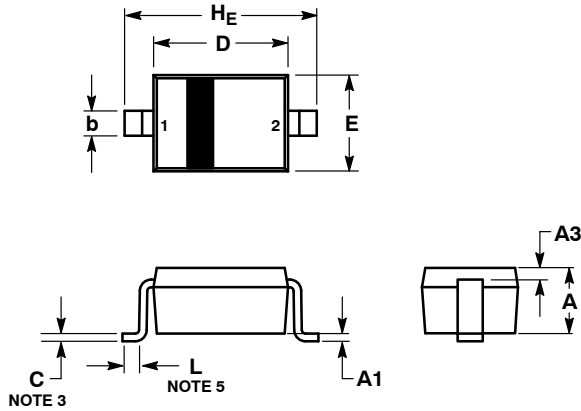


**Figure 3. Total Capacitance**

# NSR0320MW2T1G, NSVR0320MW2T1G, NSR0320MW2T3G

## PACKAGE DIMENSIONS

SOD-323  
CASE 477-02  
ISSUE H



NOTES:

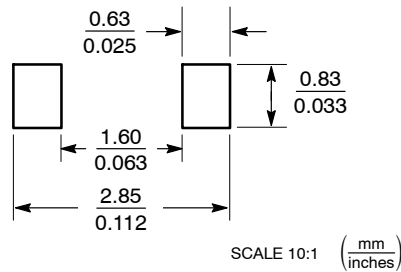
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DIMENSION L IS MEASURED FROM END OF RADIUS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.031	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.15 REF			0.006 REF		
b	0.25	0.32	0.4	0.010	0.012	0.016
C	0.089	0.12	0.177	0.003	0.005	0.007
D	1.60	1.70	1.80	0.062	0.066	0.070
E	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
HE	2.30	2.50	2.70	0.090	0.098	0.105

STYLE 1:

1. CATHODE
2. ANODE

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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